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Details

Product Status	Not For New Designs
Core Processor	HCS12
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, SPI
Peripherals	POR, PWM, WDT
Number of I/O	35
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.35V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	52-LQFP
Supplier Device Package	52-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s12c32vpbe16

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Chapter 9

Clocks and Reset Generator (CRGV4) Block Description

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Table 1-5. Signal Properties (continued)

Pin Name Function 1	Pin Name Function 2	Pin Name Function 3	Power Domain	Internal Pull Resistor		Description
				CTRL	Reset State	
PP[2:0]	KWP[2:0]	PW[2:0]	V _{DDX}	PERP/ PPSP	Disabled	Port P I/O pins, keypad wake-up, PWM outputs
PJ[7:6]	KWJ[7:6]	—	V _{DDX}	PERJ/ PPSJ	Disabled	Port J I/O pins and keypad wake-up
PM5	SCK	—	V _{DDX}	PERM/ PPSM	Up	Port M I/O pin and SPI SCK signal
PM4	MOSI	—	V _{DDX}	PERM/ PPSM	Up	Port M I/O pin and SPI MOSI signal
PM3	SS	—	V _{DDX}	PERM/ PPSM	Up	Port M I/O pin and SPI SS signal
PM2	MISO	—	V _{DDX}	PERM/ PPSM	Up	Port M I/O pin and SPI MISO signal
PM1	TXCAN	—	V _{DDX}	PERM/ PPSM	Up	Port M I/O pin and CAN transmit signal ⁽²⁾
PM0	RXCAN	—	V _{DDX}	PERM/ PPSM	Up	Port M I/O pin and CAN receive signal ²
PS[3:2]	—	—	V _{DDX}	PERS/ PPSS	Up	Port S I/O pins
PS1	TXD	—	V _{DDX}	PERS/ PPSS	Up	Port S I/O pin and SCI transmit signal
PS0	RXD	—	V _{DDX}	PERS/ PPSS	Up	Port S I/O pin and SCI receive signal
PT[7:5]	IOC[7:5]	—	V _{DDX}	PERT/ PPST	Disabled	Port T I/O pins shared with timer (TIM)
PT[4:0]	IOC[4:0]	PW[4:0]	V _{DDX}	PERT/ PPST	Disabled	Port T I/O pins shared with timer and PWM

1. The Port E output buffer enable signal control at reset is determined by the PEAR register and is mode dependent. For example, in special test mode RDWE = LSTRE = 1 which enables the PE[3:2] output buffers and disables the pull-ups. Refer to S12_MEBI user guide for PEAR register details.

2. CAN functionality is not available on the MC9S12GC Family members.

1.3.3 Pin Initialization for 48- and 52-Pin LQFP Bond Out Versions

Not Bonded Pins:

If the port pins are not bonded out in the chosen package the user should initialize the registers to be inputs with enabled pull resistance to avoid excess current consumption. This applies to the following pins:

(48LQFP): Port A[7:1], Port B[7:5], Port B[3:0], PortE[6,5,3,2], Port P[7:6], PortP[4:0], Port J[7:6], PortS[3:2]

(52LQFP): Port A[7:3], Port B[7:5], Port B[3:0], PortE[6,5,3,2], Port P[7:6], PortP[2:0], Port J[7:6], PortS[3:2]

Table 1-9. Interrupt Vector Locations (continued)

Vector Address	Interrupt Source	CCR Mask	Local Enable	HPRIO Value to Elevate
0xFFDE, 0xFFDF	Standard timer overflow	1 bit	TMSK2 (TOI)	0x00DE
0xFFDC, 0xFFDD	Pulse accumulator A overflow	1 bit	PACTL (PAOVI)	0x00DC
0xFFDA, 0xFFDB	Pulse accumulator input edge	1 bit	PACTL (PAI)	0x00DA
0xFFD8, 0xFFD9	SPI	1 bit	SPICR1 (SPIE, SPTIE)	0x00D8
0xFFD6, 0xFFD7	SCI	1 bit	SCICR2 (TIE, TCIE, RIE, ILIE)	0x00D6
0xFFD4, 0xFFD5	Reserved			
0xFFD2, 0xFFD3	ATD	1 bit	ATDCTL2 (ASCIE)	0x00D2
0xFFD0, 0xFFD1	Reserved			
0xFFCE, 0xFFCF	Port J	1 bit	PIEP (PIEP7-6)	0x00CE
0xFFCC, 0xFFCD	Reserved			
0xFFCA, 0xFFCB	Reserved			
0xFFC8, 0xFFC9	Reserved			
0xFFC6, 0xFFC7	CRG PLL lock	1 bit	PLLCR (LOCKIE)	0x00C6
0xFFC4, 0xFFC5	CRG self clock mode	1 bit	PLLCR (SCMIE)	0x00C4
0xFFBA to 0xFFC3	Reserved			
0xFFB8, 0xFFB9	FLASH	1 bit	FCNFG (CCIE, CBEIE)	0x00B8
0xFFB6, 0xFFB7	CAN wake-up ⁽¹⁾	1 bit	CANRIER (WUPIE)	0x00B6
0xFFB4, 0xFFB5	CAN errors ¹	1 bit	CANRIER (CSCIE, OVRIE)	0x00B4
0xFFB2, 0xFFB3	CAN receive ¹	1 bit	CANRIER (RXFIE)	0x00B2
0xFFB0, 0xFFB1	CAN transmit ¹	1 bit	CANTIER (TXEIE[2:0])	0x00B0
0xFF90 to 0xFFAF	Reserved			
0xFF8E, 0xFF8F	Port P	1 bit	PIEP (PIEP7-0)	0x008E
0xFF8C, 0xFF8D	Reserved			
0xFF8C, 0xFF8D	PWM Emergency Shutdown	1 bit	PWMSDN(PWMIE)	0x008C
0xFF8A, 0xFF8B	VREG LVI	1 bit	CTRL0 (LVIE)	0x008A
0xFF80 to 0xFF89	Reserved			

1. Not available on MC9S12GC Family members

2.3.2.5.7 Port J Interrupt Enable Register (PIEJ)

Module Base + 0x002E

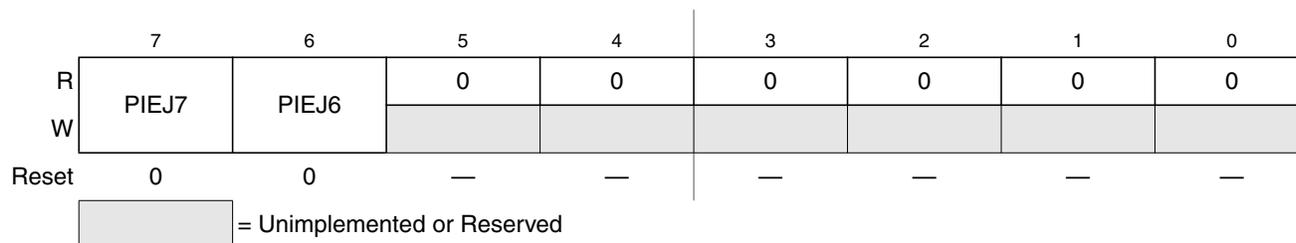


Figure 2-38. Port J Interrupt Enable Register (PIEJ)

Read: Anytime.

Write: Anytime.

Table 2-32. PIEJ Field Descriptions

Field	Description
7–6 PIEJ[7:6]	Interrupt Enable Port J — This register disables or enables on a per pin basis the edge sensitive external interrupt associated with port J. 0 Interrupt is disabled (interrupt flag masked). 1 Interrupt is enabled.

2.3.2.5.8 Port J Interrupt Flag Register (PIFJ)

Module Base + 0x002F

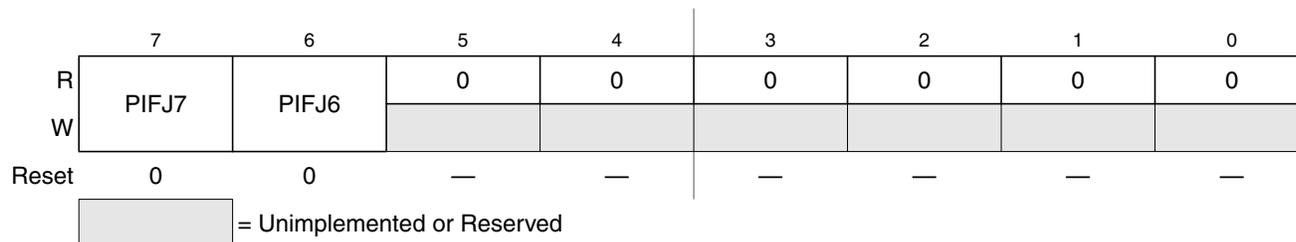


Figure 2-39. Port J Interrupt Flag Register (PIFJ)

Read: Anytime.

Write: Anytime.

Table 2-33. PIFJ Field Descriptions

Field	Description
7–6 PIFJ[7:6]	Interrupt Flags Port J — Each flag is set by an active edge on the associated input pin. This could be a rising or a falling edge based on the state of the PPSJ register. To clear this flag, write “1” to the corresponding bit in the PIFJ register. Writing a “0” has no effect. 0 No active edge pending. Writing a “0” has no effect. 1 Active edge on the associated bit has occurred (an interrupt will occur if the associated enable bit is set). Writing a “1” clears the associated flag.

There are two basic types of operating modes:

1. **Normal** modes: Some registers and bits are protected against accidental changes.
2. **Special** modes: Allow greater access to protected control registers and bits for special purposes such as testing.

A system development and debug feature, background debug mode (BDM), is available in all modes. In special single-chip mode, BDM is active immediately after reset.

Some aspects of Port E are not mode dependent. Bit 1 of Port E is a general purpose input or the $\overline{\text{IRQ}}$ interrupt input. $\overline{\text{IRQ}}$ can be enabled by bits in the CPU's condition codes register but it is inhibited at reset so this pin is initially configured as a simple input with a pull-up. Bit 0 of Port E is a general purpose input or the $\overline{\text{XIRQ}}$ interrupt input. $\overline{\text{XIRQ}}$ can be enabled by bits in the CPU's condition codes register but it is inhibited at reset so this pin is initially configured as a simple input with a pull-up. The ESTR bit in the EBICTL register is set to one by reset in any user mode. This assures that the reset vector can be fetched even if it is located in an external slow memory device. The PE6/MODB/IPIPE1 and PE5/MODA/IPIPE0 pins act as high-impedance mode select inputs during reset.

The following paragraphs discuss the default bus setup and describe which aspects of the bus can be changed after reset on a per mode basis.

4.4.3.1 Normal Operating Modes

These modes provide three operating configurations. Background debug is available in all three modes, but must first be enabled for some operations by means of a BDM background command, then activated.

4.4.3.1.1 Normal Single-Chip Mode

There is no external expansion bus in this mode. All pins of Ports A, B and E are configured as general purpose I/O pins. Port E bits 1 and 0 are available as general purpose input only pins with internal pull resistors enabled. All other pins of Port E are bidirectional I/O pins that are initially configured as high-impedance inputs with internal pull resistors enabled. Ports A and B are configured as high-impedance inputs with their internal pull resistors disabled.

The pins associated with Port E bits 6, 5, 3, and 2 cannot be configured for their alternate functions IPIPE1, IPIPE0, $\overline{\text{LSTRB}}$, and $\text{R}/\overline{\text{W}}$ while the MCU is in single chip modes. In single chip modes, the associated control bits PIPOE, LSTRE, and RDWE are reset to zero. Writing the opposite state into them in single chip mode does not change the operation of the associated Port E pins.

In normal single chip mode, the MODE register is writable one time. This allows a user program to change the bus mode to narrow or wide expanded mode and/or turn on visibility of internal accesses.

Port E, bit 4 can be configured for a free-running E clock output by clearing NECLK=0. Typically the only use for an E clock output while the MCU is in single chip modes would be to get a constant speed clock for use in the external application system.

Module Base + 0x002F

Starting address location affected by INITRG register setting.

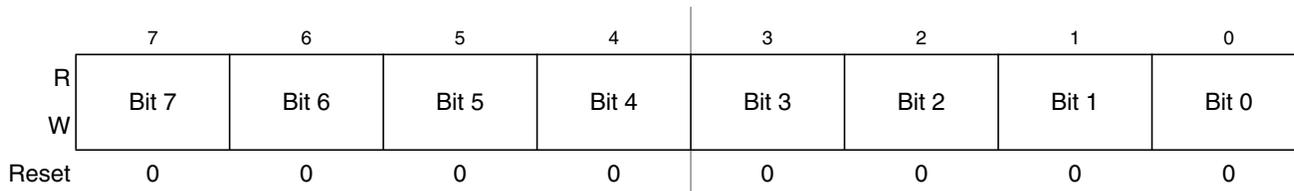


Figure 7-21. Debug Comparator B Register Low (DBGCB_L)

Table 7-23. DBGCB Field Descriptions

Field	Description
15:0	Comparator B Compare Bits — The comparator B compare bits control whether comparator B compares the address bus bits [15:0] or data bus bits [15:0] to a logic 1 or logic 0. See Table 7-20. 0 Compare corresponding address bit to a logic 0, compares to data if in Full mode 1 Compare corresponding address bit to a logic 1, compares to data if in Full mode
15:0	

7.4 Functional Description

This section provides a complete functional description of the DBG module. The DBG module can be configured to run in either of two modes, BKP or DBG. BKP mode is enabled by setting BKABEN in DBG_C2. DBG mode is enabled by setting DBGEN in DBG_C1. Setting BKABEN in DBG_C2 overrides the DBGEN in DBG_C1 and prevents DBG mode. If the part is in secure mode, DBG mode cannot be enabled.

7.4.1 DBG Operating in BKP Mode

In BKP mode, the DBG will be fully backwards compatible with the existing BKP_ST12_A module. The DBG_C2 register has four additional bits that were not available on existing BKP_ST12_A modules. As long as these bits are written to either all 1s or all 0s, they should be transparent to the user. All 1s would enable comparator C to be used as a breakpoint, but tagging would be enabled. The match address register would be all 0s if not modified by the user. Therefore, code executing at address 0x0000 would have to occur before a breakpoint based on comparator C would happen.

The DBG module in BKP mode supports two modes of operation: dual address mode and full breakpoint mode. Within each of these modes, forced or tagged breakpoint types can be used. Forced breakpoints occur at the next instruction boundary if a match occurs and tagged breakpoints allow for breaking just before the tagged instruction executes. The action taken upon a successful match can be to either place the CPU in background debug mode or to initiate a software interrupt.

The breakpoint can operate in dual address mode or full breakpoint mode. Each of these modes is discussed in the subsections below.

7.4.1.1 Dual Address Mode

When dual address mode is enabled, two address breakpoints can be set. Each breakpoint can cause the system to enter background debug mode or to initiate a software interrupt based upon the state of BDM in

Chapter 8

Analog-to-Digital Converter (ATD10B8C)

Block Description

8.1 Introduction

The ATD10B8C is an 8-channel, 10-bit, multiplexed input successive approximation analog-to-digital converter. Refer to device electrical specifications for ATD accuracy.

The block is designed to be upwards compatible with the 68HC11 standard 8-bit A/D converter. In addition, there are new operating modes that are unique to the HC12 design.

8.1.1 Features

- 8/10-bit resolution.
- 7 μ sec, 10-bit single conversion time.
- Sample buffer amplifier.
- Programmable sample time.
- Left/right justified, signed/unsigned result data.
- External trigger control.
- Conversion completion interrupt generation.
- Analog input multiplexer for eight analog input channels.
- Analog/digital input pin multiplexing.
- 1-to-8 conversion sequence lengths.
- Continuous conversion mode.
- Multiple channel scans.

8.1.2 Modes of Operation

8.1.2.1 Conversion Modes

There is software programmable selection between performing **single** or **continuous conversion** on a **single channel** or **multiple channels**.

8.3.2.13.1 Left Justified Result Data

Module Base + 0x0010 = ATDDR0H, 0x0012 = ATDDR1H, 0x0014 = ATDDR2H, 0x0016 = ATDDR3H
 0x0018 = ATDDR4H, 0x001A = ATDDR5H, 0x001C = ATDDR6H, 0x001E = ATDDR7H

	7	6	5	4	3	2	1	0	
R	BIT 9 MSB	BIT 8	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	10-bit data
W	BIT 7 MSB	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	8-bit data
Reset	0	0	0	0	0	0	0	0	

Figure 8-15. Left Justified, ATD Conversion Result Register, High Byte (ATDDRxH)

Module Base + 0x0011 = ATDDR0L, 0x0013 = ATDDR1L, 0x0015 = ATDDR2L, 0x0017 = ATDDR3L
 0x0019 = ATDDR4L, 0x001B = ATDDR5L, 0x001D = ATDDR6L, 0x001F = ATDDR7L

	7	6	5	4	3	2	1	0	
R	BIT 1	BIT 0	0	0	0	0	0	0	10-bit data
W	U	U	0	0	0	0	0	0	8-bit data
Reset	0	0	0	0	0	0	0	0	

Figure 8-16. Left Justified, ATD Conversion Result Register, Low Byte (ATDDRxL)

8.3.2.13.2 Right Justified Result Data

Module Base + 0x0010 = ATDDR0H, 0x0012 = ATDDR1H, 0x0014 = ATDDR2H, 0x0016 = ATDDR3H
 0x0018 = ATDDR4H, 0x001A = ATDDR5H, 0x001C = ATDDR6H, 0x001E = ATDDR7H

	7	6	5	4	3	2	1	0	
R	0	0	0	0	0	0	BIT 9 MSB	BIT 8	10-bit data
W	0	0	0	0	0	0	0	0	8-bit data
Reset	0	0	0	0	0	0	0	0	

Figure 8-17. Right Justified, ATD Conversion Result Register, High Byte (ATDDRxH)

Module Base + 0x0011 = ATDDR0L, 0x0013 = ATDDR1L, 0x0015 = ATDDR2L, 0x0017 = ATDDR3L
 0x0019 = ATDDR4L, 0x001B = ATDDR5L, 0x001D = ATDDR6L, 0x001F = ATDDR7L

	7	6	5	4	3	2	1	0	
R	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	10-bit data
W	BIT 7 MSB	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	8-bit data
Reset	0	0	0	0	0	0	0	0	

Figure 8-18. Right Justified, ATD Conversion Result Register, Low Byte (ATDDRxL)

12.2.4 PWM2 — Pulse Width Modulator Channel 2 Pin

This pin serves as waveform output of PWM channel 2.

12.2.5 PWM1 — Pulse Width Modulator Channel 1 Pin

This pin serves as waveform output of PWM channel 1.

12.2.6 PWM0 — Pulse Width Modulator Channel 0 Pin

This pin serves as waveform output of PWM channel 0.

12.3 Memory Map and Register Definition

This subsection describes in detail all the registers and register bits in the PWM8B6CV1 module.

The special-purpose registers and register bit functions that would not normally be made available to device end users, such as factory test control registers and reserved registers are clearly identified by means of shading the appropriate portions of address maps and register diagrams. Notes explaining the reasons for restricting access to the registers and functions are also explained in the individual register descriptions.

12.3.1 Module Memory Map

The following paragraphs describe the content of the registers in the PWM8B6CV1 module. The base address of the PWM8B6CV1 module is determined at the MCU level when the MCU is defined. The register decode map is fixed and begins at the first address of the module address offset. [Table 12-1](#) shows the registers associated with the PWM and their relative offset from the base address. The register detail description follows the order in which they appear in the register map.

Reserved bits within a register will always read as 0 and the write will be unimplemented. Unimplemented functions are indicated by shading the bit.

[Table 12-1](#) shows the memory map for the PWM8B6CV1 module.

NOTE

Register address = base address + address offset, where the base address is defined at the MCU level and the address offset is defined at the module level.

13.1.4 Block Diagram

Figure 13-1 is a high level block diagram of the SCI module, showing the interaction of various functional blocks.

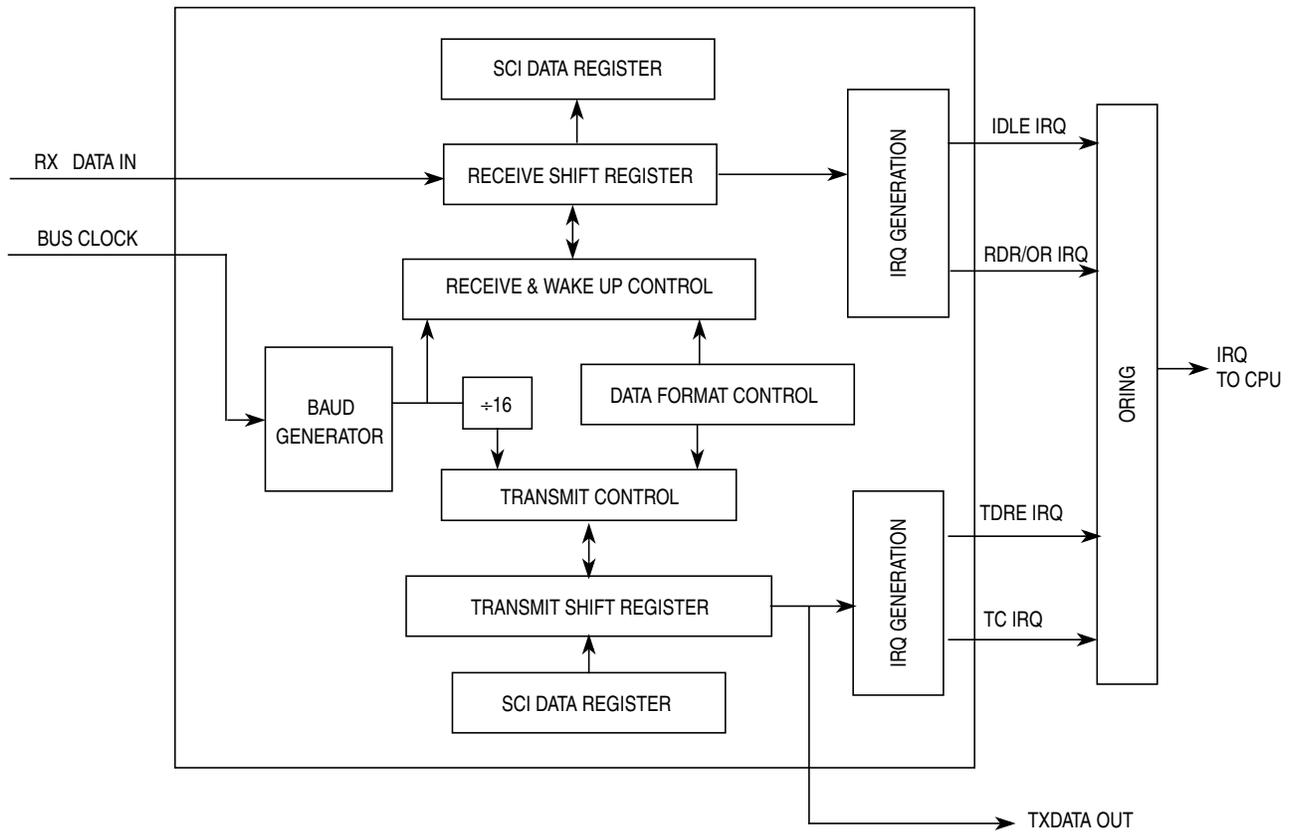


Figure 13-1. SCI Block Diagram

13.2 External Signal Description

The SCI module has a total of two external pins:

13.2.1 TXD-SCI Transmit Pin

This pin serves as transmit data output of SCI.

13.2.2 RXD-SCI Receive Pin

This pin serves as receive data input of the SCI.

Table 13-3. Loop Functions

LOOPS	RSRC	Function
0	x	Normal operation
1	0	Loop mode with Rx input internally connected to Tx output
1	1	Single-wire mode with Rx input connected to TXD

13.3.2.3 SCI Control Register 2 (SCICR2)

Module Base + 0x_0003

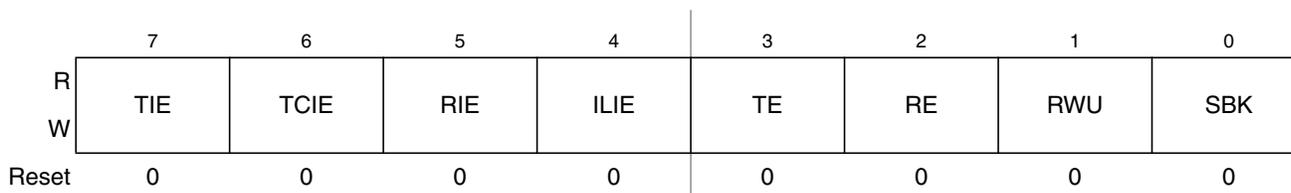


Figure 13-5. SCI Control Register 2 (SCICR2)

Read: Anytime

Write: Anytime

Table 13-4. SCICR2 Field Descriptions

Field	Description
7 TIE	Transmitter Interrupt Enable Bit — TIE enables the transmit data register empty flag, TDRE, to generate interrupt requests. 0 TDRE interrupt requests disabled 1 TDRE interrupt requests enabled
6 TCIE	Transmission Complete Interrupt Enable Bit — TCIE enables the transmission complete flag, TC, to generate interrupt requests. 0 TC interrupt requests disabled 1 TC interrupt requests enabled
5 RIE	Receiver Full Interrupt Enable Bit — RIE enables the receive data register full flag, RDRF, or the overrun flag, OR, to generate interrupt requests. 0 RDRF and OR interrupt requests disabled 1 RDRF and OR interrupt requests enabled
4 ILIE	Idle Line Interrupt Enable Bit — ILIE enables the idle line flag, IDLE, to generate interrupt requests. 0 IDLE interrupt requests disabled 1 IDLE interrupt requests enabled
3 TE	Transmitter Enable Bit — TE enables the SCI transmitter and configures the TXD pin as being controlled by the SCI. The TE bit can be used to queue an idle preamble. 0 Transmitter disabled 1 Transmitter enabled
2 RE	Receiver Enable Bit — RE enables the SCI receiver. 0 Receiver disabled 1 Receiver enabled

13.3.2.6 SCI Data Registers (SCIDRH and SCIDRL)

Module Base + 0x_0006

	7	6	5	4	3	2	1	0
R	R8	T8	0	0	0	0	0	0
W								
Reset	0	0	0	0	0	0	0	0

Module Base + 0x_0007

	7	6	5	4	3	2	1	0
R	R7	R6	R5	R4	R3	R2	R1	R0
W	T7	T6	T5	T4	T3	T2	T1	T0
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 13-8. SCI Data Registers (SCIDRH and SCIDRL)

Read: Anytime; reading accesses SCI receive data register

Write: Anytime; writing accesses SCI transmit data register; writing to R8 has no effect

Table 13-7. SCIDRH AND SCIDRL Field Descriptions

Field	Description
7 R8	Received Bit 8 — R8 is the ninth data bit received when the SCI is configured for 9-bit data format (M = 1).
6 T8	Transmit Bit 8 — T8 is the ninth data bit transmitted when the SCI is configured for 9-bit data format (M = 1).
7–0 R[7:0] T[7:0]	Received Bits — Received bits seven through zero for 9-bit or 8-bit data formats Transmit Bits — Transmit bits seven through zero for 9-bit or 8-bit formats

NOTE

If the value of T8 is the same as in the previous transmission, T8 does not have to be rewritten. The same value is transmitted until T8 is rewritten.

In 8-bit data format, only SCI data register low (SCIDRL) needs to be accessed.

When transmitting in 9-bit data format and using 8-bit write instructions, write first to SCI data register high (SCIDRH), then SCIDRL.

17.3.2.4 Flash Configuration Register (FCNFG)

The FCNFG register enables the Flash interrupts and gates the security backdoor key writes.

Module Base + 0x0003

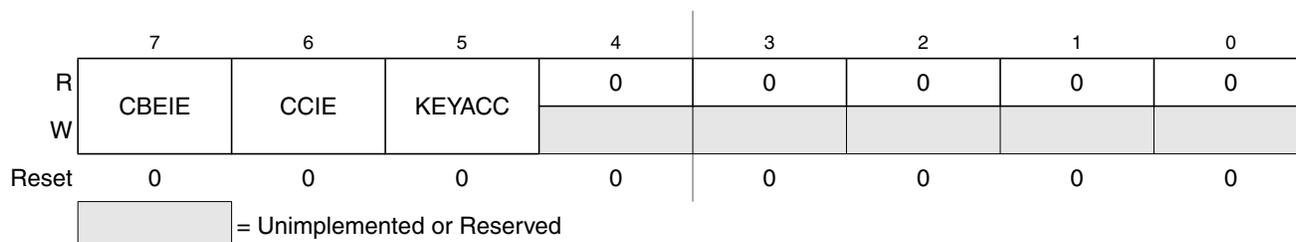


Figure 17-7. Flash Configuration Register (FCNFG)

CBEIE, CCIE, and KEYACC are readable and writable while remaining bits read 0 and are not writable. KEYACC is only writable if the KEYEN bit in the FSEC register is set to the enabled state (see [Section 17.3.2.2](#)).

Table 17-7. FCNFG Field Descriptions

Field	Description
7 CBEIE	Command Buffer Empty Interrupt Enable — The CBEIE bit enables the interrupts in case of an empty command buffer in the Flash module. 0 Command Buffer Empty interrupts disabled 1 An interrupt will be requested whenever the CBEIF flag is set (see Section 17.3.2.6)
6 CCIE	Command Complete Interrupt Enable — The CCIE bit enables the interrupts in case of all commands being completed in the Flash module. 0 Command Complete interrupts disabled 1 An interrupt will be requested whenever the CCIF flag is set (see Section 17.3.2.6)
5 KEYACC	Enable Security Key Writing. 0 Flash writes are interpreted as the start of a command write sequence 1 Writes to the Flash array are interpreted as a backdoor key while reads of the Flash array return invalid data

17.3.2.5 Flash Protection Register (FPROT)

The FPROT register defines which Flash sectors are protected against program or erase.

Module Base + 0x0004

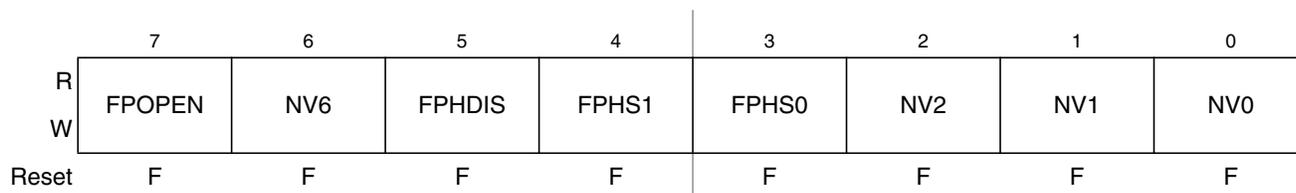


Figure 17-8. Flash Protection Register (FPROT)

The FPROT register is readable in normal and special modes. FPOPEN can only be written from a 1 to a 0. FPHS[1:0] can be written anytime until FPHDIS is cleared. The FPROT register is loaded from Flash address 0xFF0D during the reset sequence, indicated by F in [Figure 17-8](#).

17.4.1.3.3 Sector Erase Command

The sector erase operation will erase all addresses in a 512 byte sector of the Flash array using an embedded algorithm.

An example flow to execute the sector erase operation is shown in [Figure 17-24](#). The sector erase command write sequence is as follows:

1. Write to a Flash array address to start the command write sequence for the sector erase command. The Flash address written determines the sector to be erased while MCU address bits [8:0] and the data written are ignored.
2. Write the sector erase command, 0x40, to the FCMD register.
3. Clear the CBEIF flag in the FSTAT register by writing a 1 to CBEIF to launch the sector erase command.

If a Flash sector to be erased is in a protected area of the Flash array, the PVIOL flag in the FSTAT register will set and the sector erase command will not launch. Once the sector erase command has successfully launched, the CCIF flag in the FSTAT register will set after the sector erase operation has completed unless a new command write sequence has been buffered.

Table 18-12. Flash Protection Scenario Transitions

From Protection Scenario	To Protection Scenario ⁽¹⁾							
	0	1	2	3	4	5	6	7
6		X		X	X		X	
7	X	X	X	X	X	X	X	X

1. Allowed transitions marked with X.

18.3.2.6 Flash Status Register (FSTAT)

The FSTAT register defines the status of the Flash command controller and the results of command execution.

Module Base + 0x0005

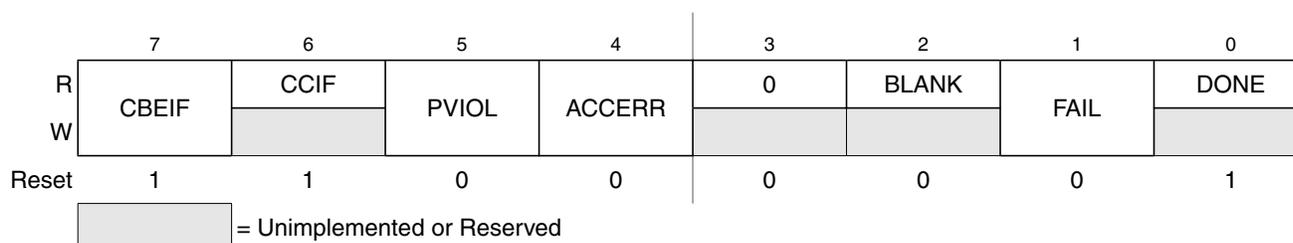


Figure 18-10. Flash Status Register (FSTAT)

In normal modes, bits CBEIF, PVIOL, and ACCERR are readable and writable, bits CCIF and BLANK are readable and not writable, remaining bits, including FAIL and DONE, read 0 and are not writable. In special modes, FAIL is readable and writable while DONE is readable but not writable. FAIL must be clear in special modes when starting a command write sequence.

Table 18-13. FSTAT Field Descriptions

Field	Description
7 CBEIF	Command Buffer Empty Interrupt Flag — The CBEIF flag indicates that the address, data and command buffers are empty so that a new command write sequence can be started. The CBEIF flag is cleared by writing a 1 to CBEIF. Writing a 0 to the CBEIF flag has no effect on CBEIF. Writing a 0 to CBEIF after writing an aligned word to the Flash address space but before CBEIF is cleared will abort a command write sequence and cause the ACCERR flag in the FSTAT register to be set. Writing a 0 to CBEIF outside of a command write sequence will not set the ACCERR flag. The CBEIF flag is used together with the CBEIE bit in the FCNFG register to generate an interrupt request (see Figure 18-26). 0 Buffers are full 1 Buffers are ready to accept a new command
6 CCIF	Command Complete Interrupt Flag — The CCIF flag indicates that there are no more commands pending. The CCIF flag is cleared when CBEIF is clear and sets automatically upon completion of all active and pending commands. The CCIF flag does not set when an active commands completes and a pending command is fetched from the command buffer. Writing to the CCIF flag has no effect. The CCIF flag is used together with the CCIE bit in the FCNFG register to generate an interrupt request (see Figure 18-26). 0 Command in progress 1 All commands are completed

Module Base + 0x0009

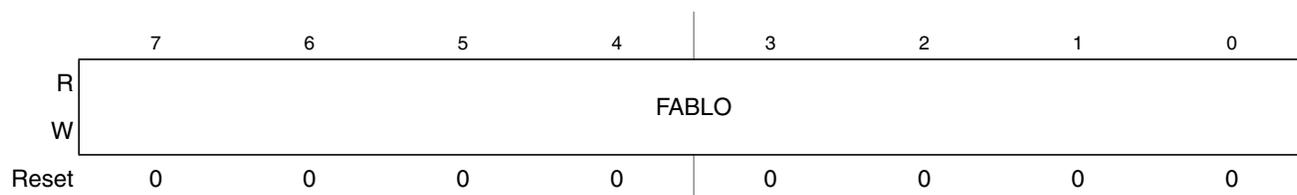


Figure 18-14. Flash Address Low Register (FADDRLO)

In normal modes, all FABHI and FABLO bits read 0 and are not writable. In special modes, the FABHI and FABLO bits are readable and writable. For sector erase, the MCU address bits [8:0] are ignored. For mass erase, any address within the Flash array is valid to start the command.

18.3.2.10 Flash Data Register (FDATA)

FDATAHI and FDATALO are the Flash data registers.

Module Base + 0x000A

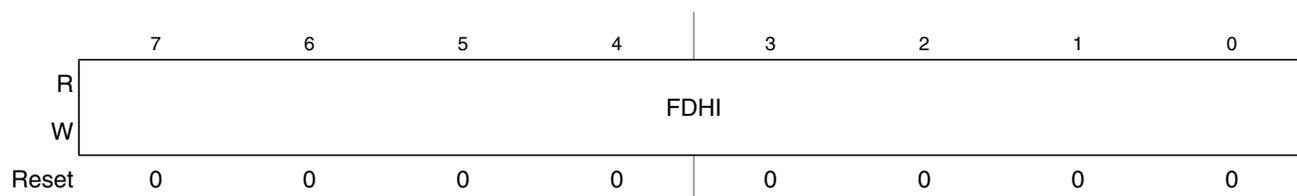


Figure 18-15. Flash Data High Register (FDATAHI)

Module Base + 0x000B

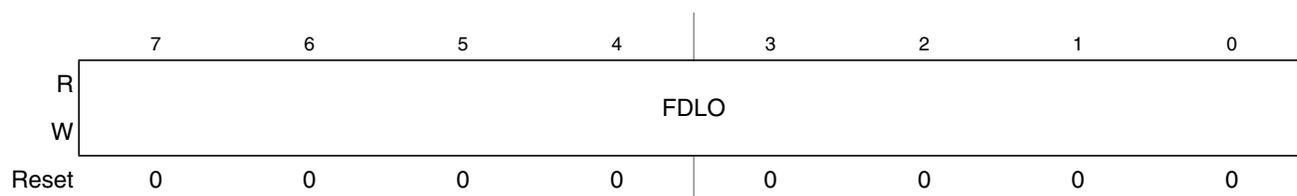


Figure 18-16. Flash Data Low Register (FDATALO)

In normal modes, all FDATAHI and FDATALO bits read 0 and are not writable. In special modes, all FDATAHI and FDATALO bits are readable and writable when writing to an address within the Flash address range.

18.3.2.11 RESERVED3

This register is reserved for factory testing and is not accessible to the user.

18.4.1.3.4 Mass Erase Command

The mass erase operation will erase all addresses in a Flash array using an embedded algorithm.

An example flow to execute the mass erase operation is shown in [Figure 18-25](#). The mass erase command write sequence is as follows:

1. Write to a Flash array address to start the command write sequence for the mass erase command. The address and data written will be ignored.
2. Write the mass erase command, 0x41, to the FCMD register.
3. Clear the CBEIF flag in the FSTAT register by writing a 1 to CBEIF to launch the mass erase command.

If a Flash array to be erased contains any protected area, the PVIOL flag in the FSTAT register will set and the mass erase command will not launch. Once the mass erase command has successfully launched, the CCIF flag in the FSTAT register will set after the mass erase operation has completed unless a new command write sequence has been buffered.

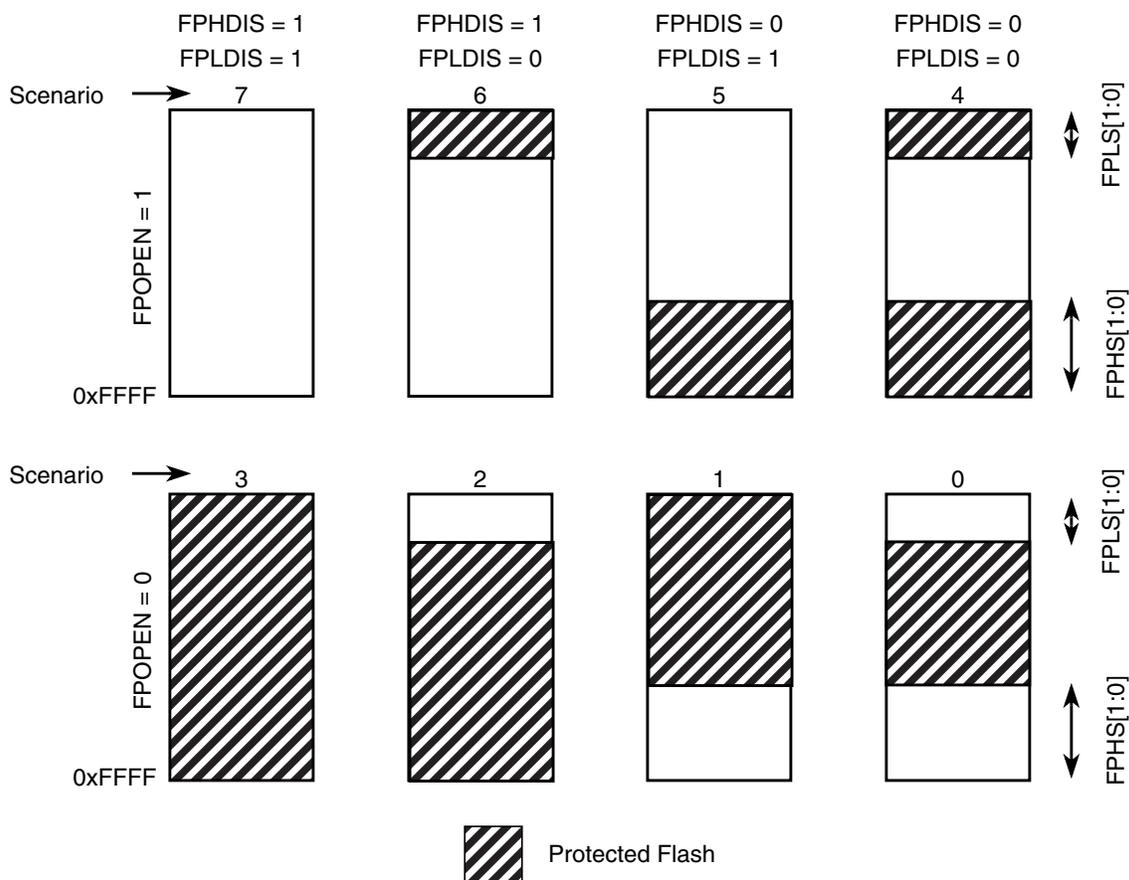


Figure 19-11. Flash Protection Scenarios

19.3.2.5.1 Flash Protection Restrictions

The general guideline is that protection can only be added, not removed. All valid transitions between Flash protection scenarios are specified in Table 19-13. Any attempt to write an invalid scenario to the FPROT register will be ignored and the FPROT register will remain unchanged. The contents of the FPROT register reflect the active protection scenario.

Table 19-13. Flash Protection Scenario Transitions

From Protection Scenario	To Protection Scenario ⁽¹⁾							
	0	1	2	3	4	5	6	7
0	X	X	X	X				
1		X		X				
2			X	X				
3				X				
4				X	X			
5			X	X	X	X		

21.4.1.4 Illegal Flash Operations

21.4.1.4.1 Access Error

The ACCERR flag in the FSTAT register will be set during the command write sequence if any of the following illegal Flash operations are performed causing the command write sequence to immediately abort:

1. Writing to the Flash address space before initializing the FCLKDIV register
2. Writing a misaligned word or a byte to the valid Flash address space
3. Writing to the Flash address space while CBEIF is not set
4. Writing a second word to the Flash address space before executing a program or erase command on the previously written word
5. Writing to any Flash register other than FCMD after writing a word to the Flash address space
6. Writing a second command to the FCMD register before executing the previously written command
7. Writing an invalid command to the FCMD register
8. Writing to any Flash register other than FSTAT (to clear CBEIF) after writing to the FCMD register
9. The part enters stop mode and a program or erase command is in progress. The command is aborted and any pending command is killed
10. When security is enabled, a command other than mass erase originating from a non-secure memory or from the background debug mode is written to the FCMD register
11. A 0 is written to the CBEIF bit in the FSTAT register to abort a command write sequence.

The ACCERR flag will not be set if any Flash register is read during the command write sequence. If the Flash array is read during execution of an algorithm (CCIF=0), the Flash module will return invalid data and the ACCERR flag will not be set. If an ACCERR flag is set in the FSTAT register, the Flash command controller is locked. It is not possible to launch another command until the ACCERR flag is cleared.

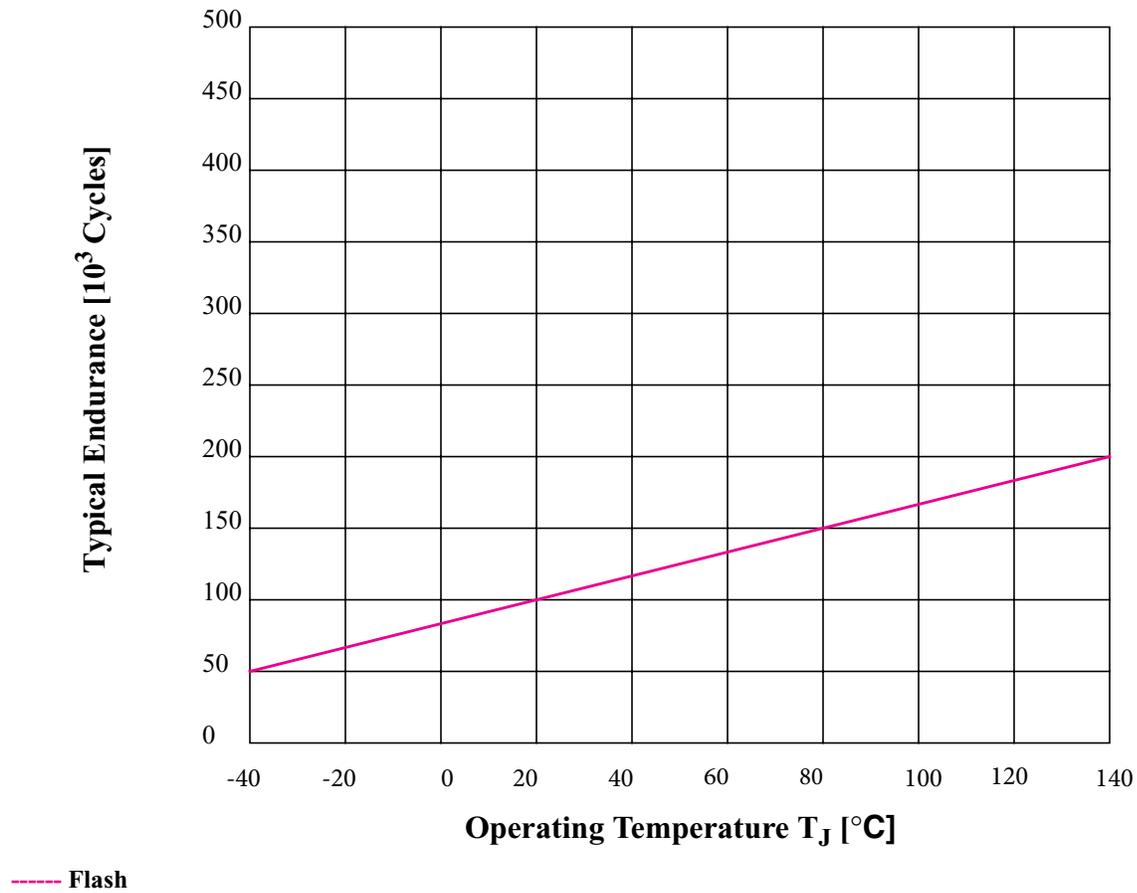
21.4.1.4.2 Protection Violation

The PVIOL flag in the FSTAT register will be set during the command write sequence after the word write to the Flash address space if any of the following illegal Flash operations are performed, causing the command write sequence to immediately abort:

1. Writing a Flash address to program in a protected area of the Flash array (see [Section 21.3.2.5](#)).
2. Writing a Flash address to erase in a protected area of the Flash array.
3. Writing the mass erase command to the FCMD register while any protection is enabled.

If the PVIOL flag is set, the Flash command controller is locked. It is not possible to launch another command until the PVIOL flag is cleared.

Figure A-5. Typical Endurance vs Temperature



A.6 SPI

This section provides electrical parametrics and ratings for the SPI.

In [Table A-20](#) the measurement conditions are listed.

Table A-20. Measurement Conditions

Description	Value	Unit
Drive mode	Full drive mode	—
Load capacitance C_{LOAD} , on all outputs	50	pF
Thresholds for delay measurement points	(20% / 80%) V_{DDX}	V

A.6.1 Master Mode

In [Figure A-6](#) the timing diagram for master mode with transmission format CPHA=0 is depicted.